

# Low Power, Long Range Sub-1 GHz Module



## **Key Features**

- Ultra low power Sub-1 GHz
- Supports 915 MHz
- Supports 2-GFSK modulation, both fixed channel mode and FHSS mode
- Supports WB-DSSS mode over 2-GFSK modulation
- Supports 30kbps, 60kbps, 120kbps, 240kbps data rate in WB-DSSS mode over 2-GFSK modulation
- Supports 5kbps, 50kbps, 200kbps data rate in FHSS mode over 2-GFSK modulation
- Powerful Cortex-M4F MCU for your IoT products
  - Clock Speed: up to 48MHz
  - Up to 352KB of In-System-Programmable Flash
  - > 80KB of Ultra-Low-Leakage SRAM
  - ➤ 30 GPIOs
- RF performance
  - > TX power: Up to +14 dBm
  - RX sensitivity: up to -121 dBm using Long-Range Mode, -110 dBm at 50 kbps (Sub-1 GHz)
- Communication range
  - At least 800 meters (LOS) @ +14 dBm, 2.5 kbps
- Ultra-low power
  - Power supply: 1.8 V ~ 3.8 V
  - > RX: 5.8 mA
  - > TX @ +14 dBm: 24.9 mA
  - > Standby: 0.85 uA (RTC running and RAM/CPU retention)
  - Shutdown: 150 nA (Wake up on external events)
- Antenna: Integrated PCB antenna
- Small Size
  - 25 mm x 15 mm x 1.7 mm (Without Shielding)
  - > 25 mm x 15 mm x 2.15 mm (With Shielding)
- Industrial grade operating temperature range from -40°C to +105°C
- FCC, CE, RoHS



## Descriptions

BDE-RFM206-IN is an ultra-low power, long-range Sub-1 GHz module targeted at low power sensors and long range applications.

BDE-RFM206-IN integrates a high performance RF core and also a powerful ARM cortex-M4F processor, which makes it suitable for certain products that need high performance MCU to deal with difficult applications.

The module supports 915 MHz bands, with the maximum output power up to 14 dBm, along with its Long-Range Mode feature, the module is to be the best choice for IoT products which utilize battery supply and require long range communication.

## **Applications**

- Long-range sensor applications
- Smart grid and automatic meter reading
- Wireless healthcare applications
- Industry monitoring and control
- Home and building automation
- Energy-harvesting applications

# **Block Diagram**

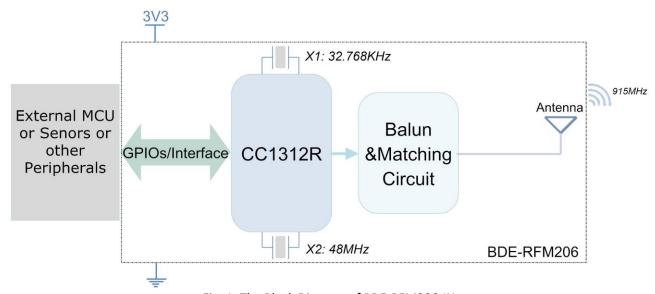


Fig. 1: The Block Diagram of BDE-RFM206-IN



### **Electrical Characteristics**

#### Absolute maximum rating

Rating	Min	Тур	Max	Unit
Storage Temperature	-40	-	125	${\mathbb C}$
VDD	-0.3	-	4.1	V
Other Digital Terminals	-0.3	-	VDDS+0.3≤4.1	V

#### ■ Recommended operating conditions

Rating	Min	Тур	Max	Unit
Operating Temperature	-40	-	105	${\mathbb C}$
VDD	1.8	3.3	3.8	V

### **Pinout**

Fig. 2 shows the pinout of BDE-RFM206-IN.

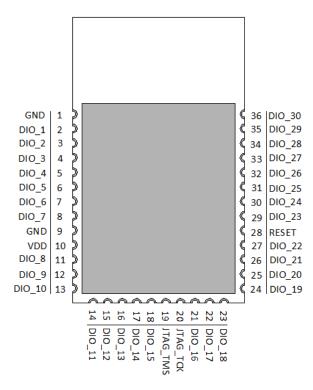


Fig. 2: The pinout of BDE-RFM206-IN (TOP VIEW)



Table 1: Pin definitions of BDE-RFM206-IN

Table 1. Fill definitions of BDE-KFIVIZOO-IIV					
Pin Number	Pin Name	Definitions			
1	GND	Power Ground			
2	DIO_1	GPIO, Sensor Controller			
3	DIO_2	GPIO, Sensor Controller			
4	DIO_3	GPIO, Sensor Controller			
5	DIO_4	GPIO, Sensor Controller			
6	DIO_5	GPIO, Sensor Controller, high-drive capability			
7	DIO_6	GPIO, Sensor Controller, high-drive capability			
8	DIO_7	GPIO, Sensor Controller, high-drive capability			
9	GND	Power Ground			
10	VDD	Power Supply			
11	DIO_8	GPIO			
12	DIO_9	GPIO			
13	DIO_10	GPIO			
14	DIO_11	GPIO			
15	DIO_12	GPIO			
16	DIO_13	GPIO			
17	DIO_14	GPIO			
18	DIO_15	GPIO			
19	JTAG_TMS	JTAG TMSC, high-drive capability			
20	JTAG_TCK	JTAG TCKC			
21	DIO_16	GPIO, JTAG_TDO, high-drive capability			
22	DIO_17	GPIO, JTAG_TDI, high-drive capability			
23	DIO_18	GPIO			
24	DIO_19	GPIO			
25	DIO_20	GPIO			
26	DIO_21	GPIO			
27	DIO_22	GPIO			
28	RESET	Reset, active-low			
29	DIO_23	GPIO, Sensor Controller, Analog			
30	DIO_24	GPIO, Sensor Controller, Analog			
31	DIO_25	GPIO, Sensor Controller, Analog			
32	DIO_26	GPIO, Sensor Controller, Analog			
33	DIO_27	GPIO, Sensor Controller, Analog			
34	DIO_28	GPIO, Sensor Controller, Analog			
35	DIO_29	GPIO, Sensor Controller, Analog			
36	DIO_30	GPIO, Sensor Controller, Analog			

# **Overall Dimensions**

Fig. 3 shows the overall dimensions of BDE-RFM206-IN. The module measures 25 mm long by 15 mm wide by 2.15 mm high with the shield.



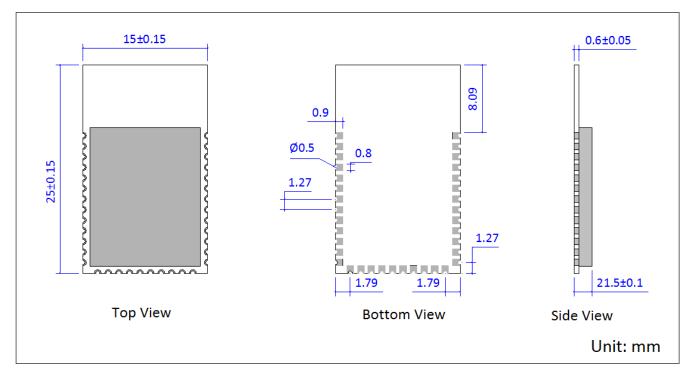


Fig. 3: Overall Dimensions of BDE-RFM206-IN

### **Module Location**

In order to get the best performance when integrating the module to your product, it is advised to use the recommended module location to the mother board.

#### Location in X-Y plane

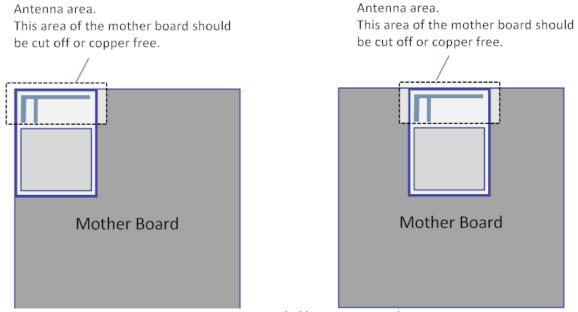


Fig. 4: Recommended location in X-Y plane



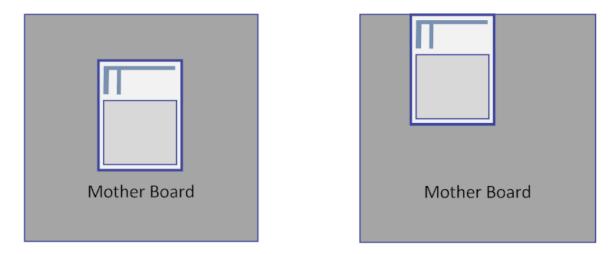


Fig. 5: Not recommended location in X-Y plane

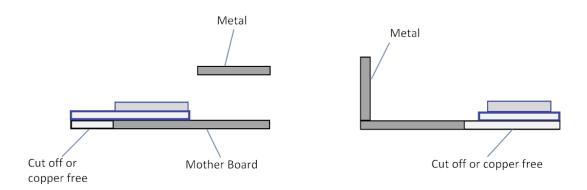


Fig. 6: Recommended location in Z plane

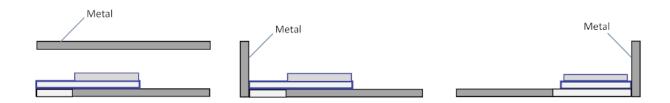
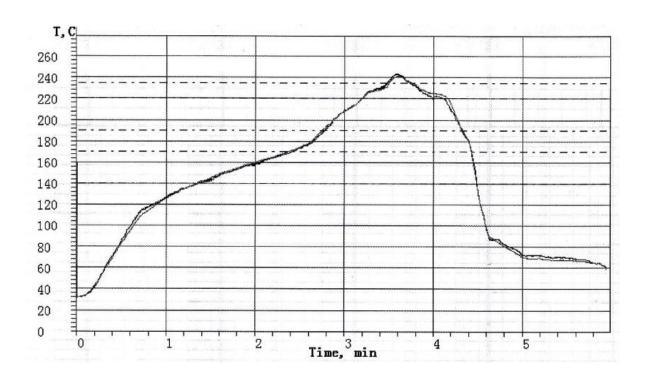


Fig. 7: Not recommended location in Z plane



# Typical Solder Reflow Profile



### **Contacts**

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